

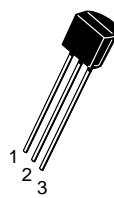
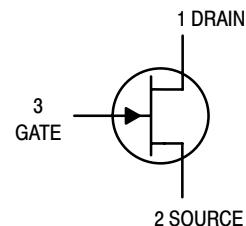
JFET VHF Amplifier

N-Channel — Depletion

MPF102

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	25	Vdc
Drain-Gate Voltage	V_{DG}	25	Vdc
Gate-Source Voltage	V_{GS}	-25	Vdc
Gate Current	I_G	10	mAdc
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	350 2.8	mW mW/ $^\circ\text{C}$
Junction Temperature Range	T_J	125	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-65 to +150	$^\circ\text{C}$

CASE 29-11, STYLE 5
TO-92 (TO-226AA)**ELECTRICAL CHARACTERISTICS** ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Gate-Source Breakdown Voltage ($I_G = -10 \mu\text{A}\text{dc}$, $V_{DS} = 0$)	$V_{(BR)GSS}$	-25	—	Vdc
Gate Reverse Current ($V_{GS} = -15 \text{ Vdc}$, $V_{DS} = 0$) ($V_{GS} = -15 \text{ Vdc}$, $V_{DS} = 0$, $T_A = 100^\circ\text{C}$)	I_{GSS}	— —	-2.0 -2.0	nAdc $\mu\text{A}\text{dc}$
Gate-Source Cutoff Voltage ($V_{DS} = 15 \text{ Vdc}$, $I_D = 2.0 \text{ nA}\text{dc}$)	$V_{GS(off)}$	—	-8.0	Vdc
Gate-Source Voltage ($V_{DS} = 15 \text{ Vdc}$, $I_D = 0.2 \text{ mA}\text{dc}$)	V_{GS}	-0.5	-7.5	Vdc
ON CHARACTERISTICS				
Zero-Gate-Voltage Drain Current ⁽¹⁾ ($V_{DS} = 15 \text{ Vdc}$, $V_{GS} = 0 \text{ Vdc}$)	I_{DSS}	2.0	20	mA\text{dc}

SMALL-SIGNAL CHARACTERISTICS

Forward Transfer Admittance ⁽¹⁾ ($V_{DS} = 15 \text{ Vdc}$, $V_{GS} = 0$, $f = 1.0 \text{ kHz}$) ($V_{DS} = 15 \text{ Vdc}$, $V_{GS} = 0$, $f = 100 \text{ MHz}$)	$ y_{fs} $	2000 1600	7500 —	μmhos
Input Admittance ($V_{DS} = 15 \text{ Vdc}$, $V_{GS} = 0$, $f = 100 \text{ MHz}$)	$\text{Re}(y_{is})$	—	800	μmhos
Output Conductance ($V_{DS} = 15 \text{ Vdc}$, $V_{GS} = 0$, $f = 100 \text{ MHz}$)	$\text{Re}(y_{os})$	—	200	μmhos
Input Capacitance ($V_{DS} = 15 \text{ Vdc}$, $V_{GS} = 0$, $f = 1.0 \text{ MHz}$)	C_{iss}	—	7.0	pF
Reverse Transfer Capacitance ($V_{DS} = 15 \text{ Vdc}$, $V_{GS} = 0$, $f = 1.0 \text{ MHz}$)	C_{rss}	—	3.0	pF

1. Pulse Test; Pulse Width $\leq 630 \text{ ms}$, Duty Cycle $\leq 10\%$.

POWER GAIN

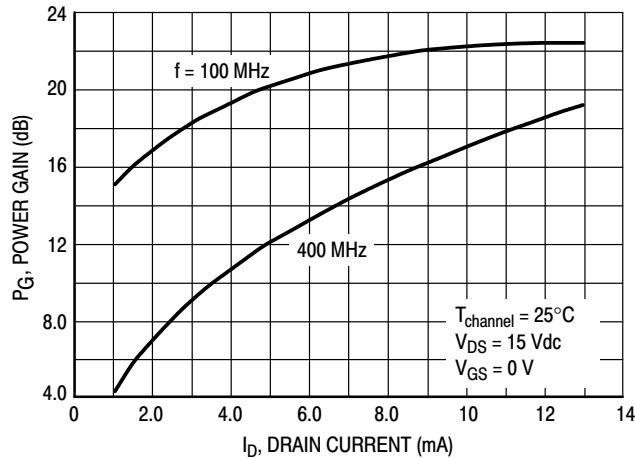
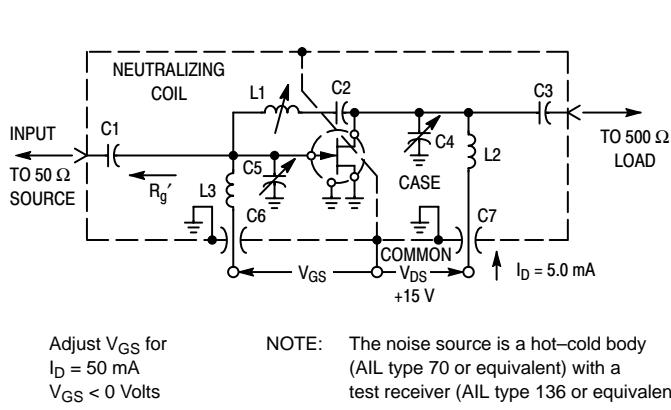


Figure 1. Effects of Drain Current



Reference Designation	VALUE	
	100 MHz	400 MHz
C1	7.0 pF	1.8 pF
C2	1000 pF	17 pF
C3	3.0 pF	1.0 pF
C4	1-12 pF	0.8-8.0 pF
C5	1-12 pF	0.8-8.0 pF
C6	0.0015 μF	0.001 μF
C7	0.0015 μF	0.001 μF
L1	3.0 μH^*	0.2 μH^{**}
L2	0.15 μH^*	0.03 μH^{**}
L3	0.14 μH^*	0.022 μH^{**}

- *L1 17 turns, (approx. — depends upon circuit layout) AWG #28 enameled copper wire, close wound on 9/32" ceramic coil form. Tuning provided by a powdered iron slug.
- L2 4-1/2 turns, AWG #18 enameled copper wire, 5/16" long, 3/8" I.D. (AIR CORE).
- L3 3-1/2 turns, AWG #18 enameled copper wire, 1/4" long, 3/8" I.D. (AIR CORE).

- **L1 6 turns, (approx. — depends upon circuit layout) AWG #24 enameled copper wire, close wound on 7/32" ceramic coil form. Tuning provided by an aluminum slug.
- L2 1 turn, AWG #16 enameled copper wire, 3/8" I.D. (AIR CORE).
- L3 1/2 turn, AWG #16 enameled copper wire, 1/4" I.D. (AIR CORE).

Figure 2. 100 MHz and 400 MHz Neutralized Test Circuit

MPF102

NOISE FIGURE

($T_{\text{channel}} = 25^\circ\text{C}$)

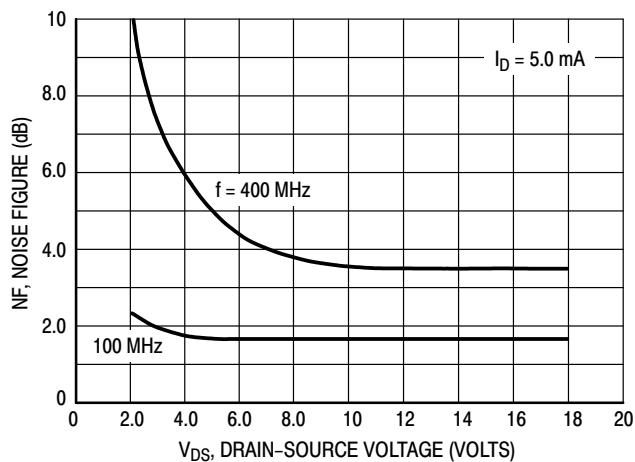


Figure 3. Effects of Drain–Source Voltage

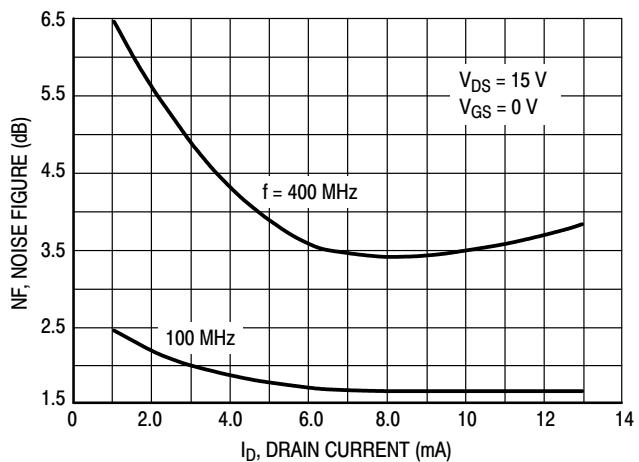


Figure 4. Effects of Drain Current

INTERMODULATION CHARACTERISTICS

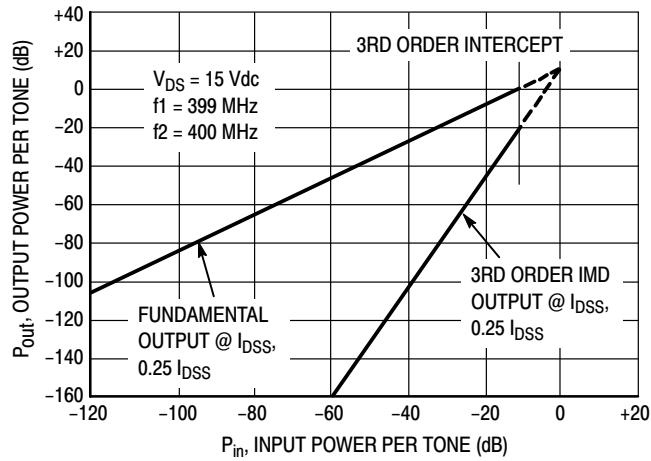


Figure 5. Third Order Intermodulation Distortion

**COMMON SOURCE CHARACTERISTICS
ADMITTANCE PARAMETERS**
($V_{DS} = 15$ Vdc, $T_{channel} = 25^\circ\text{C}$)

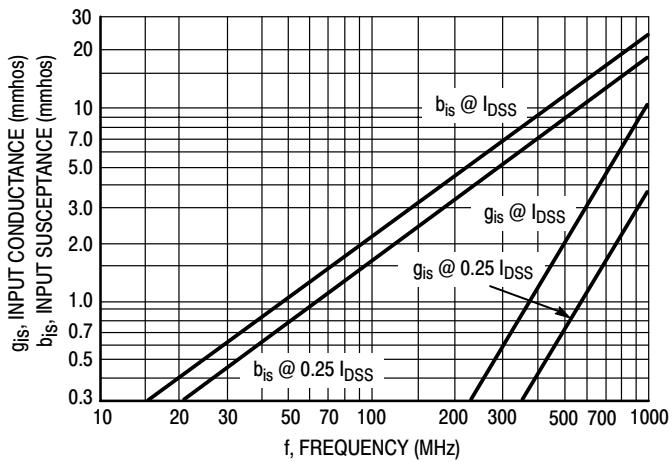


Figure 6. Input Admittance (y_{is})

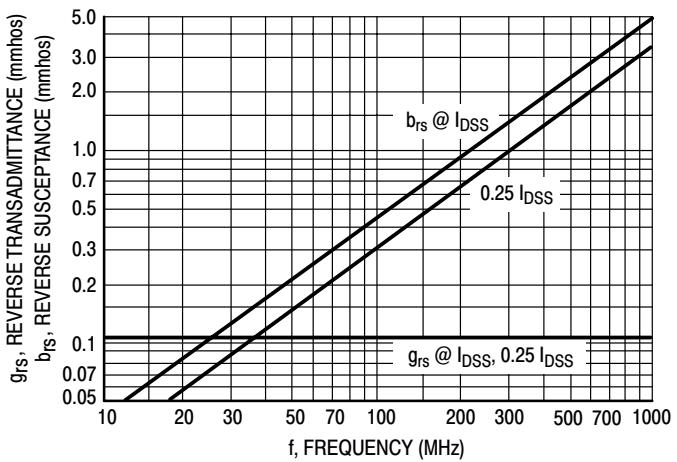


Figure 7. Reverse Transfer Admittance (y_{rs})

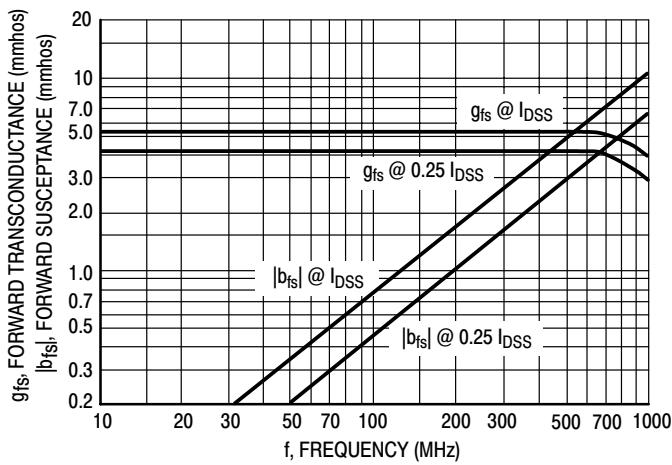


Figure 8. Forward Transadmittance (y_{fs})

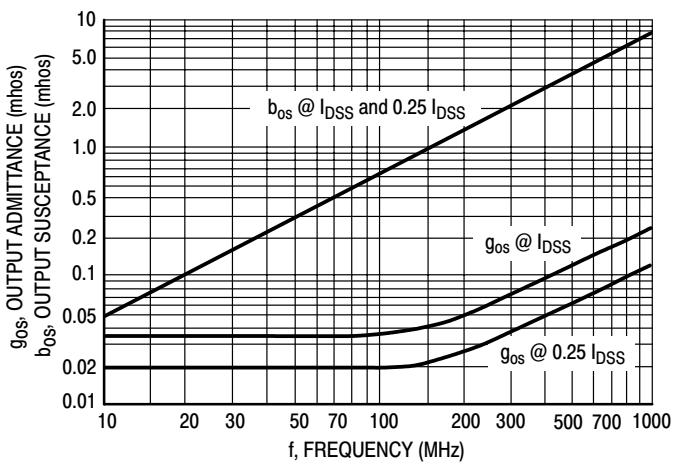


Figure 9. Output Admittance (y_{os})

**COMMON SOURCE CHARACTERISTICS
S-PARAMETERS**

($V_{DS} = 15$ Vdc, $T_{channel} = 25^\circ\text{C}$, Data Points in MHz)

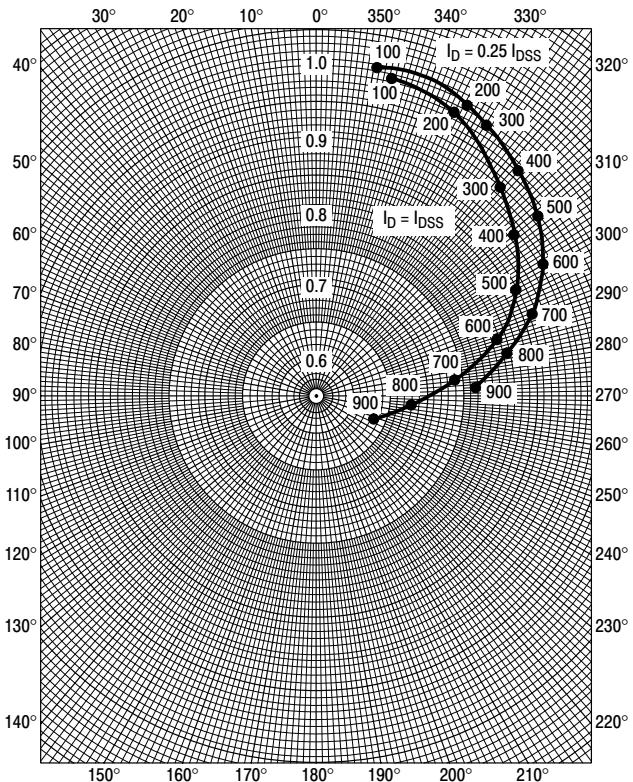


Figure 10. S_{11s}

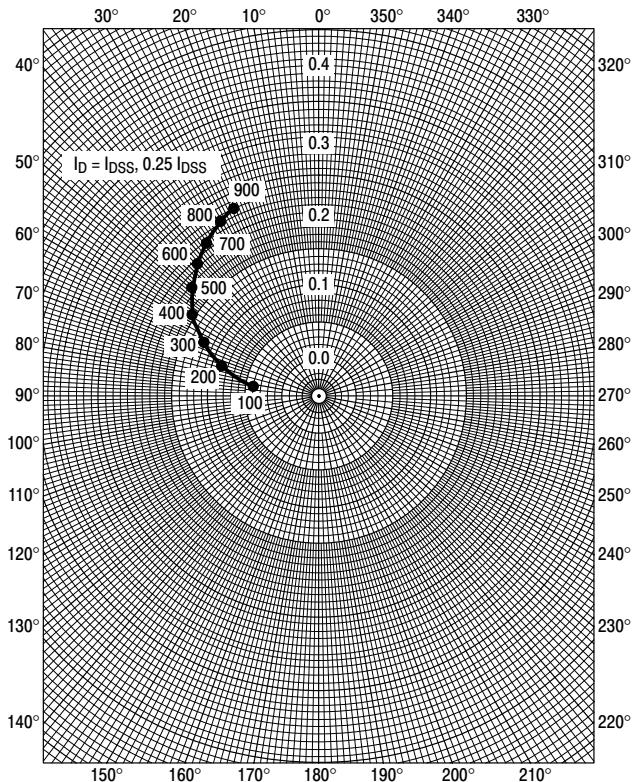
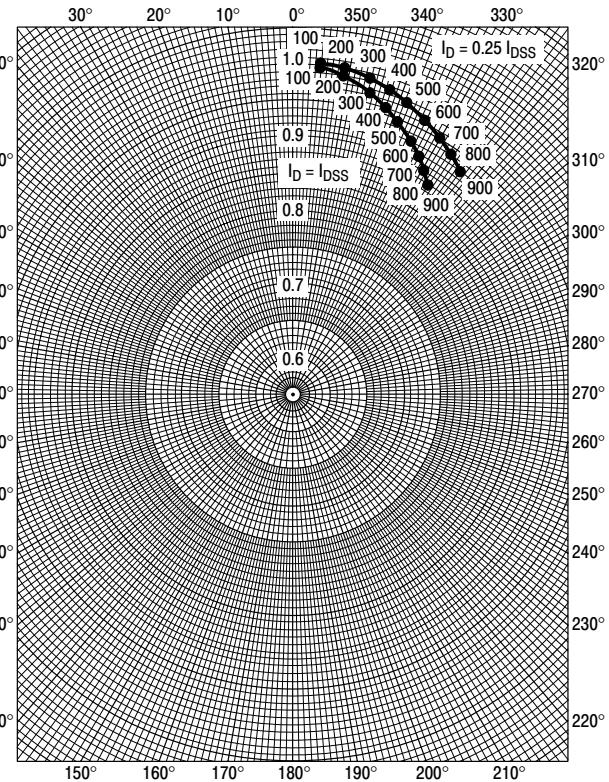
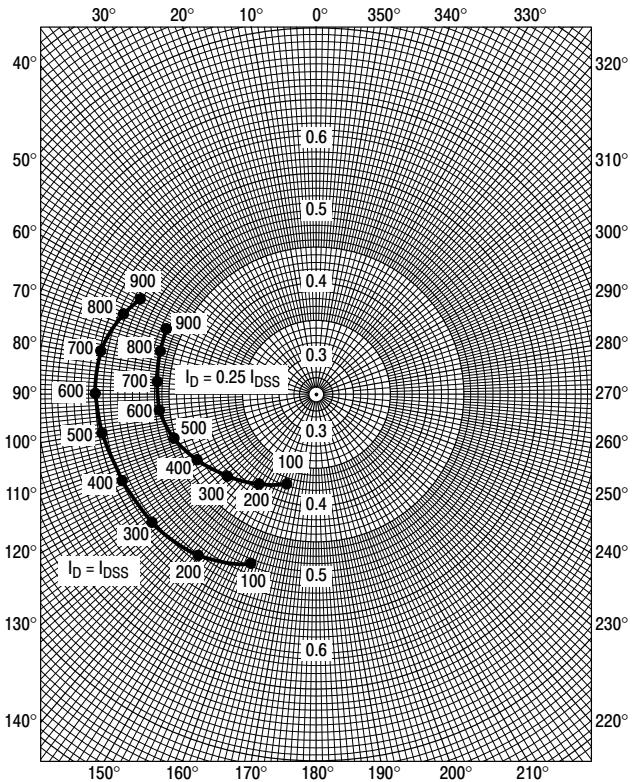


Figure 11. S_{12s}



COMMON GATE CHARACTERISTICS
ADMITTANCE PARAMETERS
 $(V_{DG} = 15 \text{ Vdc}, T_{channel} = 25^\circ\text{C})$

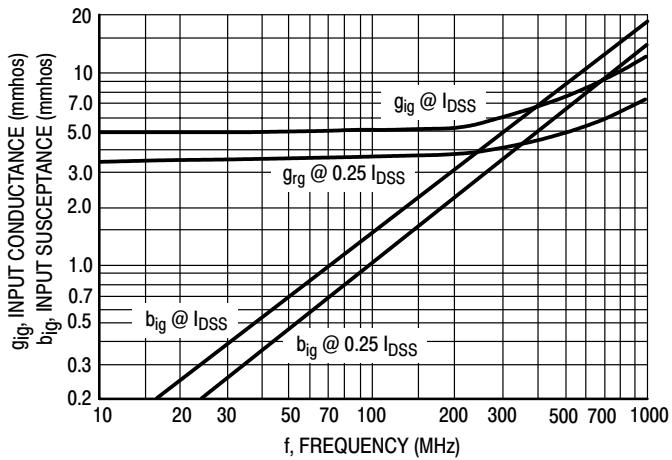


Figure 14. Input Admittance (y_{ig})

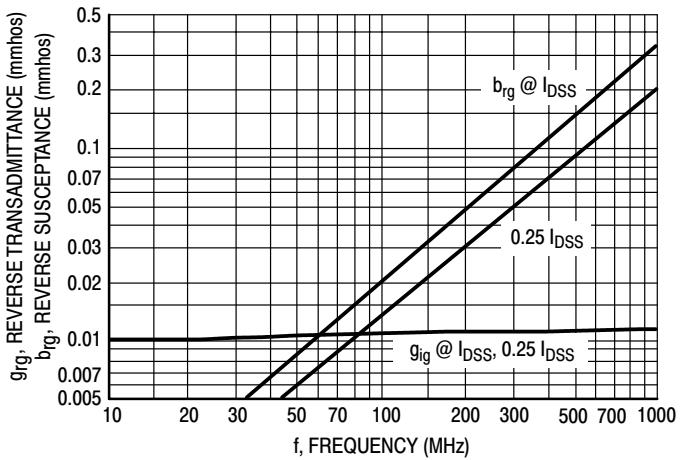


Figure 15. Reverse Transfer Admittance (y_{rg})

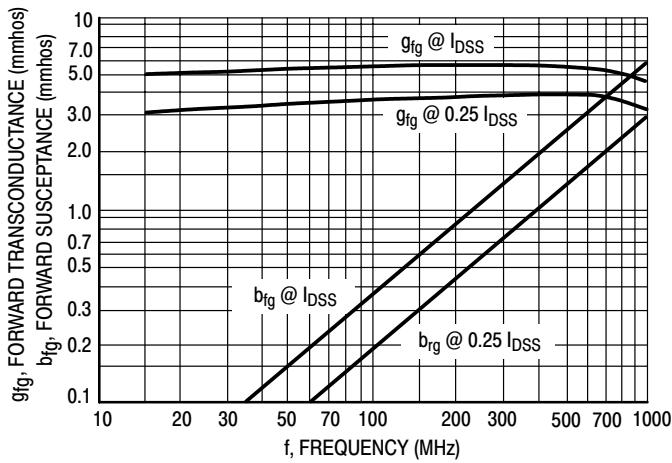


Figure 16. Forward Transfer Admittance (y_{fg})

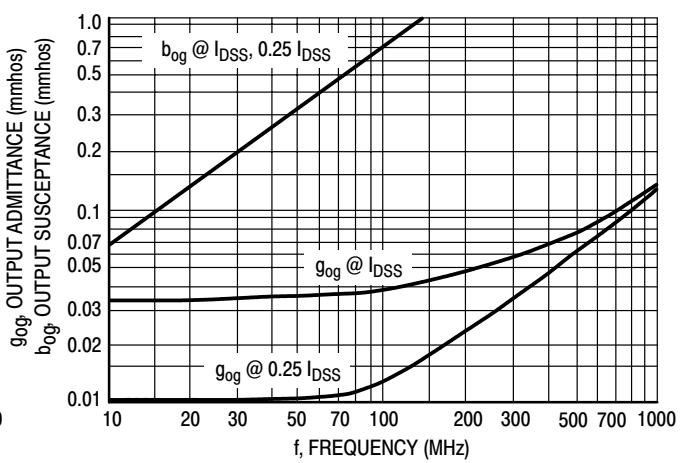


Figure 17. Output Admittance (y_{og})

**COMMON GATE CHARACTERISTICS
S-PARAMETERS**

($V_{DS} = 15$ Vdc, $T_{channel} = 25^\circ\text{C}$, Data Points in MHz)

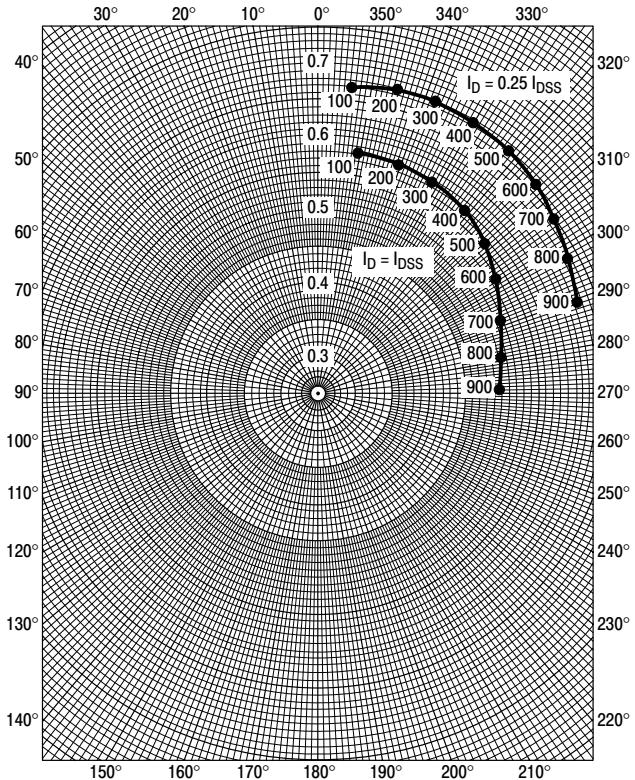


Figure 18. S_{11g}

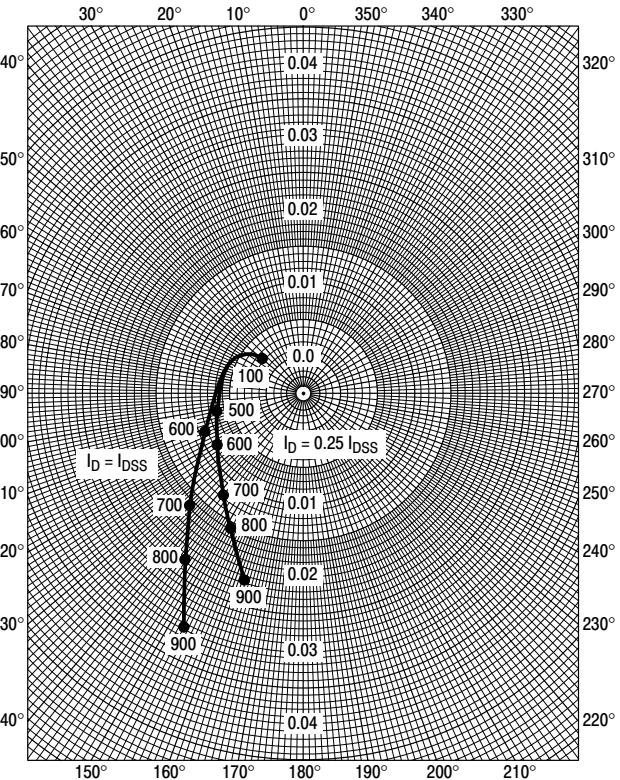
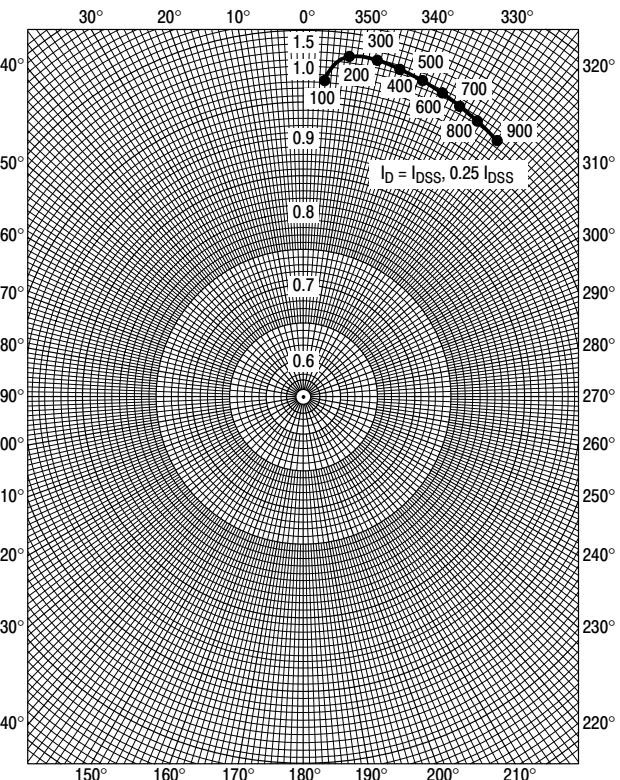
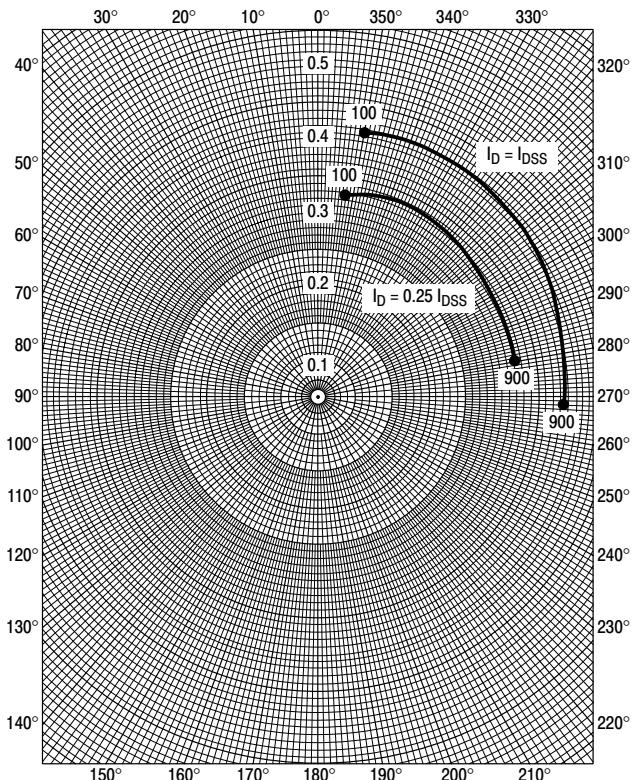
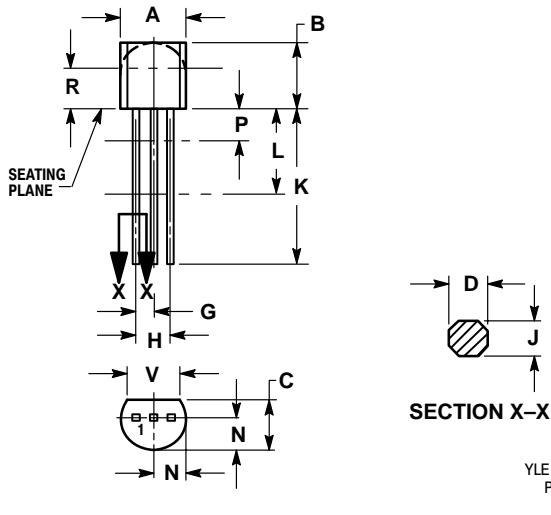


Figure 19. S_{12g}



PACKAGE DIMENSIONS

TO-92 (TO-226AB)
CASE 29-11
ISSUE AL

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.175	0.205	4.45	5.20
B	0.170	0.210	4.32	5.33
C	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
H	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500	---	12.70	---
L	0.250	---	6.35	---
N	0.080	0.105	2.04	2.66
P	---	0.100	---	2.54
R	0.115	---	2.93	---
V	0.135	---	3.43	---

YLE 5:
PIN 1. DRAIN
2. SOURCE
3. GATE

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